



**THE DATASHEET OF
MC34072DR2G**



MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A



ON Semiconductor®

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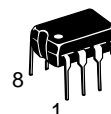
Single Supply 3.0 V to 44 V Operational Amplifiers

Quality bipolar fabrication with innovative design concepts are employed for the MC33071/72/74, MC34071/72/74, NCV33072/74A series of monolithic operational amplifiers. This series of operational amplifiers offer 4.5 MHz of gain bandwidth product, 13 V/ μ s slew rate and fast settling time without the use of JFET device technology. Although this series can be operated from split supplies, it is particularly suited for single supply operation, since the common mode input voltage range includes ground potential (V_{EE}). With a Darlington input stage, this series exhibits high input resistance, low input offset voltage and high gain. The all NPN output stage, characterized by no deadband crossover distortion and large output voltage swing, provides high capacitance drive capability, excellent phase and gain margins, low open loop high frequency output impedance and symmetrical source/sink AC frequency response.

The MC33071/72/74, MC34071/72/74, NCV33072/74,A series of devices are available in standard or prime performance (A Suffix) grades and are specified over the commercial, industrial/vehicular or military temperature ranges. The complete series of single, dual and quad operational amplifiers are available in plastic DIP, SOIC, QFN and TSSOP surface mount packages.

Features

- Wide Bandwidth: 4.5 MHz
- High Slew Rate: 13 V/ μ s
- Fast Settling Time: 1.1 μ s to 0.1%
- Wide Single Supply Operation: 3.0 V to 44 V
- Wide Input Common Mode Voltage Range: Includes Ground (V_{EE})
- Low Input Offset Voltage: 3.0 mV Maximum (A Suffix)
- Large Output Voltage Swing: -14.7 V to +14 V (with ± 15 V Supplies)
- Large Capacitance Drive Capability: 0 pF to 10,000 pF
- Low Total Harmonic Distortion: 0.02%
- Excellent Phase Margin: 60°
- Excellent Gain Margin: 12 dB
- Output Short Circuit Protection
- ESD Diodes/Clamps Provide Input Protection for Dual and Quad
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



PDIP-8
P SUFFIX
CASE 626



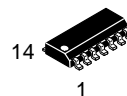
SOIC-8
D SUFFIX
CASE 751



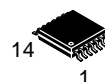
WQFN10
MT SUFFIX
CASE 510AJ



PDIP-14
P SUFFIX
CASE 646



SOIC-14
D SUFFIX
CASE 751A



TSSOP-14
DTB SUFFIX
CASE 948G

ORDERING INFORMATION

See detailed ordering and shipping information on page 18 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 21 of this data sheet.

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

PIN CONNECTIONS

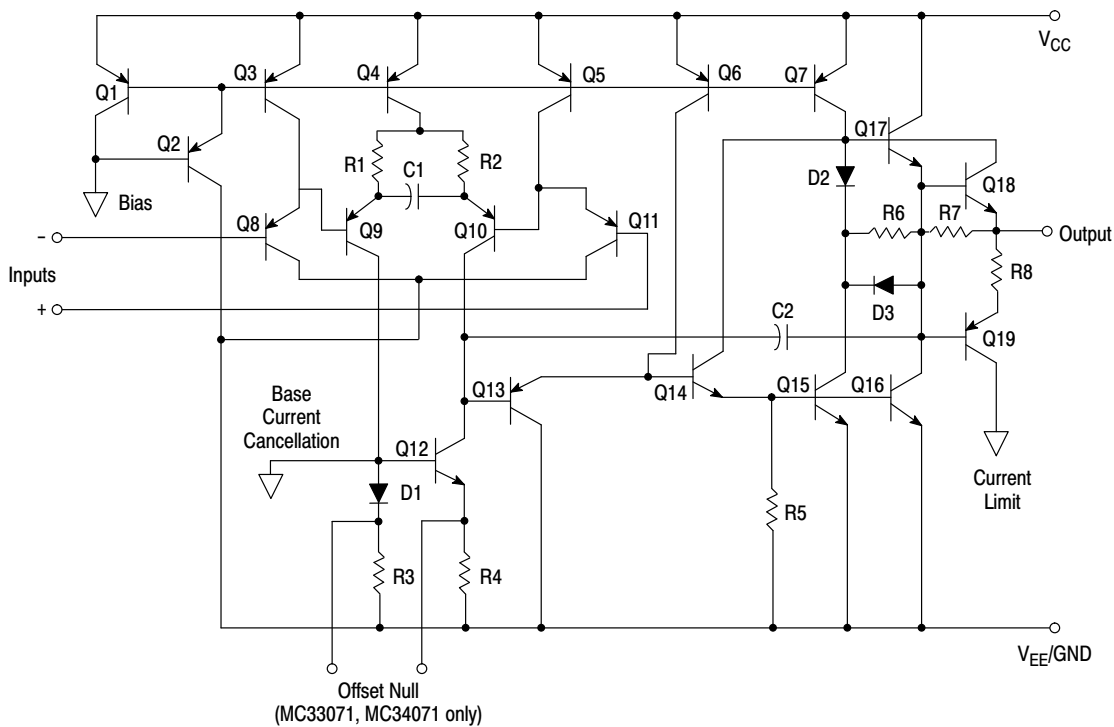
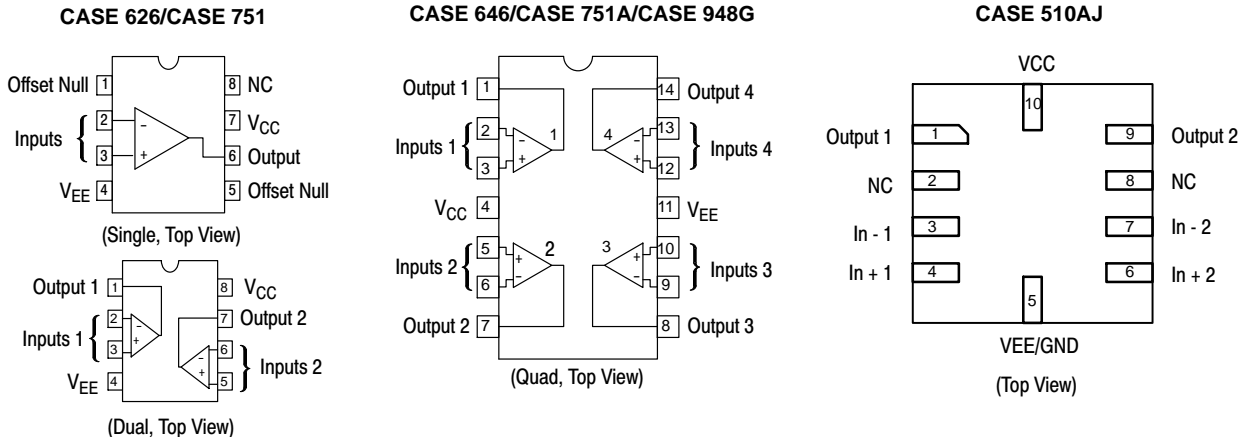


Figure 1. Representative Schematic Diagram
(Each Amplifier)

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage (from V_{EE} to V_{CC})	V_S	+44	V
Input Differential Voltage Range	V_{IDR}	(Note 1)	V
Input Voltage Range	V_{IR}	(Note 1)	V
Output Short Circuit Duration (Note 2)	t_{SC}	Indefinite	Sec
Operating Junction Temperature	T_J	+150	°C
Storage Temperature Range	T_{stg}	-60 to +150	°C
ESD Capability, Dual and Quad (Note 3)			V
Human Body Model	ESD_{HBM}	2000	
Machine Model	ESD_{MM}	200	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Either or both input voltages should not exceed the magnitude of V_{CC} or V_{EE} .
2. Power dissipation must be considered to ensure maximum junction temperature (T_J) is not exceeded (see Figure 2).
3. This device series incorporates ESD protection and is tested by the following methods:
 - ESD Human Body Model tested per AEC-Q100-002 (JEDEC standard: JESD22-A114)
 - ESD Machine Model tested per AEC-Q100-003 (JEDEC standard: JESD22-A115)

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ELECTRICAL CHARACTERISTICS ($V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $R_L =$ connected to ground, unless otherwise noted. See Note 4 for $T_A = T_{low}$ to T_{high})

Characteristics	Symbol	A Suffix			Non-Suffix			Unit
		Min	Typ	Max	Min	Typ	Max	
Input Offset Voltage ($R_S = 100\ \Omega$, $V_{CM} = 0\text{ V}$, $V_O = 0\text{ V}$) $V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $T_A = +25^\circ\text{C}$ $V_{CC} = +5.0\text{ V}$, $V_{EE} = 0\text{ V}$, $T_A = +25^\circ\text{C}$ $V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $T_A = T_{low}$ to T_{high}	V_{IO}	– – –	0.5 0.5 –	3.0 3.0 5.0	– – –	1.0 1.5 –	5.0 5.0 7.0	mV
Average Temperature Coefficient of Input Offset Voltage $R_S = 10\ \Omega$, $V_{CM} = 0\text{ V}$, $V_O = 0\text{ V}$, $T_A = T_{low}$ to T_{high}	$\Delta V_{IO}/\Delta T$	–	10	–	–	10	–	$\mu\text{V}/^\circ\text{C}$
Input Bias Current ($V_{CM} = 0\text{ V}$, $V_O = 0\text{ V}$) $T_A = +25^\circ\text{C}$ $T_A = T_{low}$ to T_{high}	I_{IB}	– –	100 –	500 700	– –	100 –	500 700	nA
Input Offset Current ($V_{CM} = 0\text{ V}$, $V_O = 0\text{ V}$) $T_A = +25^\circ\text{C}$ $T_A = T_{low}$ to T_{high}	I_{IO}	– –	6.0 –	50 300	– –	6.0 –	75 300	nA
Input Common Mode Voltage Range $T_A = +25^\circ\text{C}$ $T_A = T_{low}$ to T_{high}	V_{ICR}	V_{EE} to $(V_{CC} - 1.8)$ V_{EE} to $(V_{CC} - 2.2)$			V_{EE} to $(V_{CC} - 1.8)$ V_{EE} to $(V_{CC} - 2.2)$			V
Large Signal Voltage Gain ($V_O = \pm 10\text{ V}$, $R_L = 2.0\text{ k}\Omega$) $T_A = +25^\circ\text{C}$ $T_A = T_{low}$ to T_{high}	A_{VOL}	50 25	100 –	– –	25 20	100 –	– –	V/mV
Output Voltage Swing ($V_{ID} = \pm 1.0\text{ V}$) $V_{CC} = +5.0\text{ V}$, $V_{EE} = 0\text{ V}$, $R_L = 2.0\text{ k}\Omega$, $T_A = +25^\circ\text{C}$ $V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $R_L = 10\text{ k}\Omega$, $T_A = +25^\circ\text{C}$ $V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $R_L = 2.0\text{ k}\Omega$, $T_A = T_{low}$ to T_{high}	V_{OH}	3.7 13.6 13.4	4.0 14 –	– – –	3.7 13.6 13.4	4.0 14 –	– – –	V
$V_{CC} = +5.0\text{ V}$, $V_{EE} = 0\text{ V}$, $R_L = 2.0\text{ k}\Omega$, $T_A = +25^\circ\text{C}$ $V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $R_L = 10\text{ k}\Omega$, $T_A = +25^\circ\text{C}$ $V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $R_L = 2.0\text{ k}\Omega$, $T_A = T_{low}$ to T_{high}	V_{OL}	– – –	0.1 –14.7 –	0.3 –14.3 –13.5	– – –	0.1 –14.7 –	0.3 –14.3 –13.5	V
Output Short Circuit Current ($V_{ID} = 1.0\text{ V}$, $V_O = 0\text{ V}$, $T_A = 25^\circ\text{C}$) Source Sink	I_{SC}	10 20	30 30	– –	10 20	30 30	– –	mA
Common Mode Rejection $R_S \leq 10\text{ k}\Omega$, $V_{CM} = V_{ICR}$, $T_A = 25^\circ\text{C}$	CMR	80	97	–	70	97	–	dB
Power Supply Rejection ($R_S = 100\ \Omega$) $V_{CC}/V_{EE} = +16.5\text{ V}/-16.5\text{ V}$ to $+13.5\text{ V}/-13.5\text{ V}$, $T_A = 25^\circ\text{C}$	PSR	80	97	–	70	97	–	dB
Power Supply Current (Per Amplifier, No Load) $V_{CC} = +5.0\text{ V}$, $V_{EE} = 0\text{ V}$, $V_O = +2.5\text{ V}$, $T_A = +25^\circ\text{C}$ $V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $V_O = 0\text{ V}$, $T_A = +25^\circ\text{C}$ $V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $V_O = 0\text{ V}$, $T_A = T_{low}$ to T_{high}	I_D	– – –	1.6 1.9 –	2.0 2.5 2.8	– – –	1.6 1.9 –	2.0 2.5 2.8	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. $T_{low} = -40^\circ\text{C}$ for MC33071,2,4,/A, NCV33074/A $T_{high} = +85^\circ\text{C}$ for MC33071,2,4,/A, NCV33074/A
 $= 0^\circ\text{C}$ for MC34071,2,4,/A $= +70^\circ\text{C}$ for MC34071,2,4,/A
 $= -40^\circ\text{C}$ for MC34072,4/V, NCV33072,4A $= +125^\circ\text{C}$ for MC34072,4/V, NCV33072,4A, NCV34074V
 Case 510AJ T_{low}/T_{high} guaranteed by product characterization.

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AC ELECTRICAL CHARACTERISTICS ($V_{CC} = +15\text{ V}$, $V_{EE} = -15\text{ V}$, $R_L =$ connected to ground. $T_A = +25^\circ\text{C}$, unless otherwise noted.)

Characteristics	Symbol	A Suffix			Non-Suffix			Unit
		Min	Typ	Max	Min	Typ	Max	
Slew Rate ($V_{in} = -10\text{ V}$ to $+10\text{ V}$, $R_L = 2.0\text{ k}\Omega$, $C_L = 500\text{ pF}$) $A_V = +1.0$ $A_V = -1.0$	SR	8.0	10	–	8.0	10	–	V/ μs
Setting Time (10 V Step, $A_V = -1.0$) To 0.1% (+1/2 LSB of 9-Bits) To 0.01% (+1/2 LSB of 12-Bits)	t_s	–	1.1	–	–	1.1	–	μs
Gain Bandwidth Product ($f = 100\text{ kHz}$)	GBW	3.5	4.5	–	3.5	4.5	–	MHz
Power Bandwidth $A_V = +1.0$, $R_L = 2.0\text{ k}\Omega$, $V_O = 20\text{ V}_{pp}$, THD = 5.0%	BW	–	160	–	–	160	–	kHz
Phase margin $R_L = 2.0\text{ k}\Omega$ $R_L = 2.0\text{ k}\Omega$, $C_L = 300\text{ pF}$	f_m	–	60	–	–	60	–	Deg
Gain Margin $R_L = 2.0\text{ k}\Omega$ $R_L = 2.0\text{ k}\Omega$, $C_L = 300\text{ pF}$	A_m	–	12	–	–	12	–	dB
Equivalent Input Noise Voltage $R_S = 100\ \Omega$, $f = 1.0\text{ kHz}$	e_n	–	32	–	–	32	–	nV/ $\sqrt{\text{Hz}}$
Equivalent Input Noise Current $f = 1.0\text{ kHz}$	i_n	–	0.22	–	–	0.22	–	pA/ $\sqrt{\text{Hz}}$
Differential Input Resistance $V_{CM} = 0\text{ V}$	R_{in}	–	150	–	–	150	–	M Ω
Differential Input Capacitance $V_{CM} = 0\text{ V}$	C_{in}	–	2.5	–	–	2.5	–	pF
Total Harmonic Distortion $A_V = +10$, $R_L = 2.0\text{ k}\Omega$, $2.0\text{ V}_{pp} \leq V_O \leq 20\text{ V}_{pp}$, $f = 10\text{ kHz}$	THD	–	0.02	–	–	0.02	–	%
Channel Separation ($f = 10\text{ kHz}$)	–	–	120	–	–	120	–	dB
Open Loop Output Impedance ($f = 1.0\text{ MHz}$)	$ Z_O $	–	30	–	–	30	–	W



Figure 2. Power Supply Configurations



Offset nulling range is approximately $\pm 80\text{ mV}$ with a 10 k potentiometer (MC33071, MC34071 only).

Figure 3. Offset Null Circuit

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Figure 4. Maximum Power Dissipation versus Temperature for Package Types

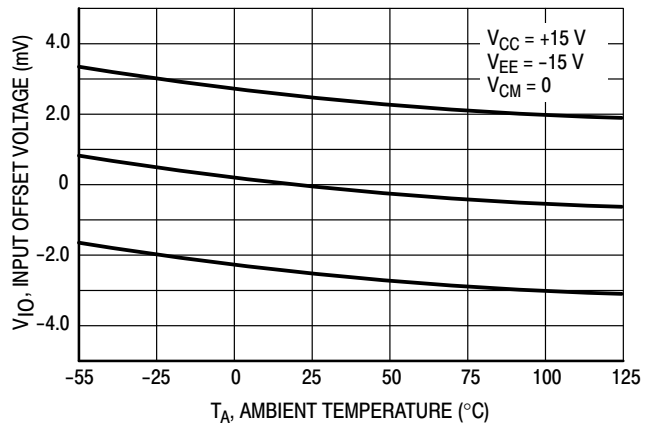


Figure 5. Input Offset Voltage versus Temperature for Representative Units



Figure 6. Input Common Mode Voltage Range versus Temperature

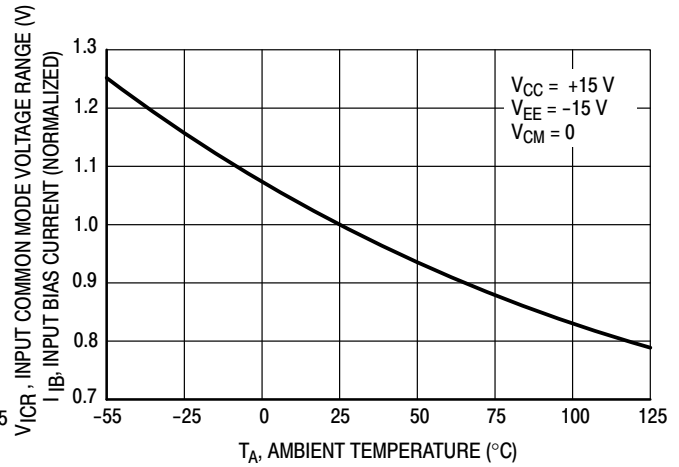


Figure 7. Normalized Input Bias Current versus Temperature



Figure 8. Normalized Input Bias Current versus Input Common Mode Voltage



Figure 9. Split Supply Output Voltage Swing versus Supply Voltage



Figure 10. Split Supply Output Saturation versus Load Current



Figure 11. Single Supply Output Saturation versus Load Resistance to Ground



Figure 12. Single Supply Output Saturation versus Load Resistance to V_{CC}



Figure 13. Output Short Circuit Current versus Temperature



Figure 14. Output Impedance versus Frequency



Figure 15. Output Voltage Swing versus Frequency



Figure 16. Total Harmonic Distortion versus Frequency



Figure 17. Total Harmonic Distortion versus Output Voltage Swing



Figure 18. Open Loop Voltage Gain versus Temperature



Figure 19. Open Loop Voltage Gain and Phase versus Frequency



Figure 20. Open Loop Voltage Gain and Phase versus Frequency



Figure 21. Normalized Gain Bandwidth Product versus Temperature

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A



Figure 22. Percent Overshoot versus Load Capacitance



Figure 23. Phase Margin versus Load Capacitance



Figure 24. Gain Margin versus Load Capacitance



Figure 25. Phase Margin versus Temperature



Figure 26. Gain Margin versus Temperature



Figure 27. Phase Margin and Gain Margin versus Differential Source Resistance

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A



Figure 28. Normalized Slew Rate versus Temperature



Figure 29. Output Settling Time



Figure 30. Small Signal Transient Response



Figure 31. Large Signal Transient Response



Figure 32. Common Mode Rejection versus Frequency



Figure 33. Power Supply Rejection versus Frequency

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A



Figure 34. Supply Current versus Supply Voltage

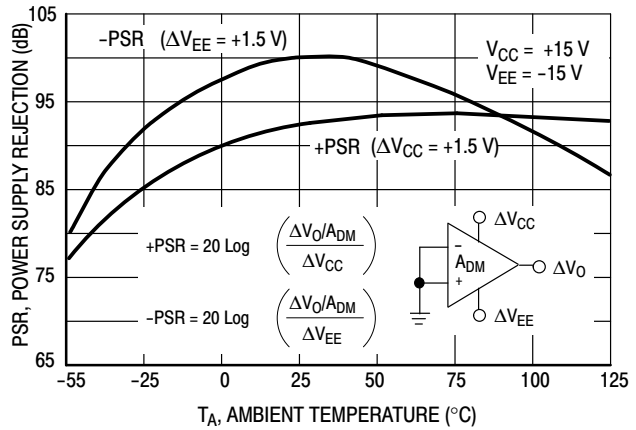


Figure 35. Power Supply Rejection versus Temperature



Figure 36. Channel Separation versus Frequency



Figure 37. Input Noise versus Frequency

APPLICATIONS INFORMATION CIRCUIT DESCRIPTION/PERFORMANCE FEATURES

Although the bandwidth, slew rate, and settling time of the MC34071 amplifier series are similar to op amp products utilizing JFET input devices, these amplifiers offer other additional distinct advantages as a result of the PNP transistor differential input stage and an all NPN transistor output stage.

Since the input common mode voltage range of this input stage includes the V_{EE} potential, single supply operation is feasible to as low as 3.0 V with the common mode input voltage at ground potential.

The input stage also allows differential input voltages up to ± 44 V, provided the maximum input voltage range is not exceeded. Specifically, the input voltages must range between V_{EE} and V_{CC} supply voltages as shown by the maximum rating table. In practice, although not recommended, the input voltages can exceed the V_{CC} voltage by approximately 3.0 V and decrease below the V_{EE} voltage by 0.3 V without causing product damage, although output phase reversal may occur. It is also possible to source

up to approximately 5.0 mA of current from V_{EE} through either inputs clamping diode without damage or latching, although phase reversal may again occur.

If one or both inputs exceed the upper common mode voltage limit, the amplifier output is readily predictable and may be in a low or high state depending on the existing input bias conditions.

Since the input capacitance associated with the small geometry input device is substantially lower (2.5 pF) than the typical JFET input gate capacitance (5.0 pF), better frequency response for a given input source resistance can be achieved using the MC34071 series of amplifiers. This performance feature becomes evident, for example, in fast settling D-to-A current to voltage conversion applications where the feedback resistance can form an input pole with the input capacitance of the op amp. This input pole creates a 2nd order system with the single pole op amp and is therefore detrimental to its settling time. In this context, lower input capacitance is desirable especially for higher

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values of feedback resistances (lower current DACs). This input pole can be compensated for by creating a feedback zero with a capacitance across the feedback resistance, if necessary, to reduce overshoot. For 2.0 k Ω of feedback resistance, the MC34071 series can settle to within 1/2 LSB of 8-bits in 1.0 μ s, and within 1/2 LSB of 12-bits in 2.2 μ s for a 10 V step. In an inverting unity gain fast settling configuration, the symmetrical slew rate is ± 13 V/ μ s. In the classic noninverting unity gain configuration, the output positive slew rate is +10 V/ μ s, and the corresponding negative slew rate will exceed the positive slew rate as a function of the fall time of the input waveform.

Since the bipolar input device matching characteristics are superior to that of JFETs, a low untrimmed maximum offset voltage of 3.0 mV prime and 5.0 mV downgrade can be economically offered with high frequency performance characteristics. This combination is ideal for low cost precision, high speed quad op amp applications.

The all NPN output stage, shown in its basic form on the equivalent circuit schematic, offers unique advantages over the more conventional NPN/PNP transistor Class AB output stage. A 10 k Ω load resistance can swing within 1.0 V of the positive rail (V_{CC}), and within 0.3 V of the negative rail (V_{EE}), providing a 28.7 V_{pp} swing from ± 15 V supplies. This large output swing becomes most noticeable at lower supply voltages.

The positive swing is limited by the saturation voltage of the current source transistor Q₇, and V_{BE} of the NPN pull up transistor Q₁₇, and the voltage drop associated with the short circuit resistance, R₇. The negative swing is limited by the saturation voltage of the pull-down transistor Q₁₆, the voltage drop $I_L R_6$, and the voltage drop associated with resistance R₇, where I_L is the sink load current. For small valued sink currents, the above voltage drops are negligible, allowing the negative swing voltage to approach within millivolts of V_{EE} . For large valued sink currents (>5.0 mA), diode D3 clamps the voltage across R₆, thus limiting the negative swing to the saturation voltage of Q₁₆, plus the forward diode drop of D3 ($\approx V_{EE} + 1.0$ V). Thus for a given supply voltage, unprecedented peak-to-peak output voltage swing is possible as indicated by the output swing specifications.

If the load resistance is referenced to V_{CC} instead of ground for single supply applications, the maximum possible output swing can be achieved for a given supply voltage. For light load currents, the load resistance will pull the output to V_{CC} during the positive swing and the output will pull the load resistance near ground during the negative swing. The load resistance value should be much less than that of the feedback resistance to maximize pull up capability.

Because the PNP output emitter-follower transistor has been eliminated, the MC34071 series offers a 20 mA minimum current sink capability, typically to an output voltage of ($V_{EE} + 1.8$ V). In single supply applications the output can directly source or sink base current from a common emitter NPN transistor for fast high current switching applications.

In addition, the all NPN transistor output stage is inherently fast, contributing to the bipolar amplifier's high gain bandwidth product and fast settling capability. The associated high frequency low output impedance (30 Ω typ @ 1.0 MHz) allows capacitive drive capability from 0 pF to 10,000 pF without oscillation in the unity closed loop gain configuration. The 60° phase margin and 12 dB gain margin as well as the general gain and phase characteristics are virtually independent of the source/sink output swing conditions. This allows easier system phase compensation, since output swing will not be a phase consideration. The high frequency characteristics of the MC34071 series also allow excellent high frequency active filter capability, especially for low voltage single supply applications.

Although the single supply specifications is defined at 5.0 V, these amplifiers are functional to 3.0 V @ 25°C although slight changes in parametrics such as bandwidth, slew rate, and DC gain may occur.

If power to this integrated circuit is applied in reverse polarity or if the IC is installed backwards in a socket, large unlimited current surges will occur through the device that may result in device destruction.

Special static precautions are not necessary for these bipolar amplifiers since there are no MOS transistors on the die.

As with most high frequency amplifiers, proper lead dress, component placement, and PC board layout should be exercised for optimum frequency performance. For example, long unshielded input or output leads may result in unwanted input-output coupling. In order to preserve the relatively low input capacitance associated with these amplifiers, resistors connected to the inputs should be immediately adjacent to the input pin to minimize additional stray input capacitance. This not only minimizes the input pole for optimum frequency response, but also minimizes extraneous "pick up" at this node. Supply decoupling with adequate capacitance immediately adjacent to the supply pin is also important, particularly over temperature, since many types of decoupling capacitors exhibit great impedance changes over temperature.

The output of any one amplifier is current limited and thus protected from a direct short to ground. However, under such conditions, it is important not to allow the device to exceed the maximum junction temperature rating. Typically for ± 15 V supplies, any one output can be shorted continuously to ground without exceeding the maximum temperature rating.

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(Typical Single Supply Applications $V_{CC} = 5.0\text{ V}$)



Figure 38. AC Coupled Noninverting Amplifier



Figure 39. AC Coupled Inverting Amplifier



Figure 40. DC Coupled Inverting Amplifier
Maximum Output Swing



Figure 41. Unity Gain Buffer TTL Driver



Figure 42. Active High-Q Notch Filter



Given $f_0 =$ Center Frequency
 $A_0 =$ Gain at Center Frequency
 Choose Value f_0, Q, A_0, C

$$\text{Then: } R_3 = \frac{Q}{\pi f_0 C} \quad R_1 = \frac{R_3}{2H_0} \quad R_2 = \frac{R_1 R_3}{4Q^2 R_1 - R_3}$$

For less than 10% error from operational amplifier $\frac{Q_0 f_0}{GBW} < 0.1$

where f_0 and GBW are expressed in Hz.

GBW = 4.5 MHz Typ.

Figure 43. Active Bandpass Filter

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A



Figure 44. Low Voltage Fast D/A Converter

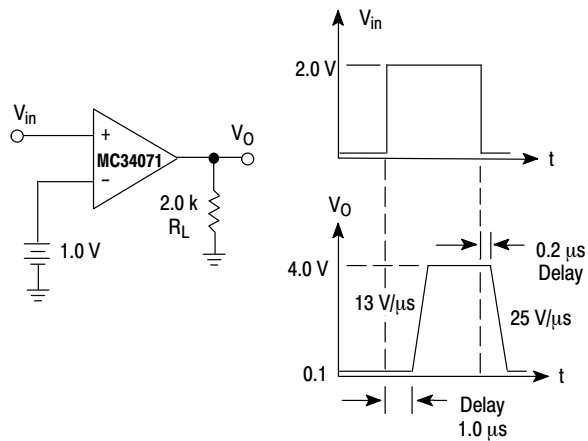


Figure 45. High Speed Low Voltage Comparator



Figure 46. LED Driver

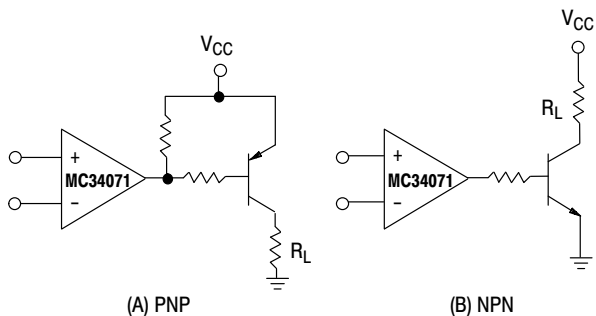


Figure 47. Transistor Driver



Figure 48. AC/DC Ground Current Monitor



Figure 49. Photovoltaic Cell Amplifier

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A



Figure 50. Low Input Voltage Comparator with Hysteresis



Figure 51. High Compliance Voltage to Sink Current Converter



Figure 52. High Input Impedance Differential Amplifier



Figure 53. Bridge Current Amplifier



Figure 54. Low Voltage Peak Detector



Figure 55. High Frequency Pulse Width Modulation

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

GENERAL ADDITIONAL APPLICATIONS INFORMATION $V_S = \pm 15.0\text{ V}$



Figure 56. Second Order Low-Pass Active Filter



Figure 57. Second Order High-Pass Active Filter



Figure 58. Fast Settling Inverter

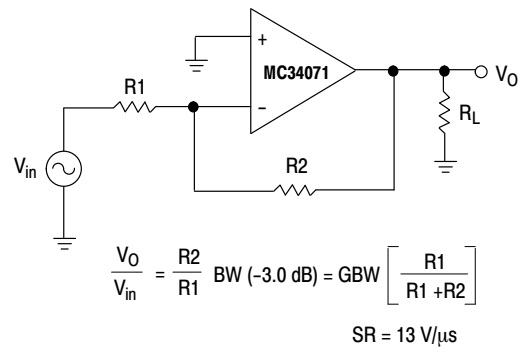


Figure 59. Basic Inverting Amplifier



Figure 60. Basic Noninverting Amplifier



Figure 61. Unity Gain Buffer ($A_V = +1.0$)

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A



Figure 62. High Impedance Differential Amplifier



Figure 63. Dual Voltage Doubler

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

ORDERING INFORMATION

Op Amp Function	Device	Operating Temperature Range	Package	Shipping†
Single	MC34071PG	T _A = 0° to +70°C	PDIP-8 (Pb-Free)	50 Units / Rail
	MC34071APG		PDIP-8 (Pb-Free)	50 Units / Rail
	MC34071DG		SOIC-8 (Pb-Free)	98 Units / Rail
	MC34071DR2G		SOIC-8 (Pb-Free)	2500 / Tape & Reel
	MC34071ADG		SOIC-8 (Pb-Free)	98 Units / Rail
	MC34071ADR2G		SOIC-8 (Pb-Free)	2500 / Tape & Reel
	MC33071PG	T _A = -40° to +85°C	PDIP-8 (Pb-Free)	50 Units / Rail
	MC33071APG		PDIP-8 (Pb-Free)	50 Units / Rail
	MC33071DG		SOIC-8 (Pb-Free)	98 Units / Rail
	MC33071DR2G		SOIC-8 (Pb-Free)	2500 / Tape & Reel
	MC33071ADG		SOIC-8 (Pb-Free)	98 Units / Rail
	MC33071ADR2G		SOIC-8 (Pb-Free)	2500 / Tape & Reel

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

ORDERING INFORMATION (continued)

Op Amp Function	Device	Operating Temperature Range	Package	Shipping†
Dual	MC34072PG	$T_A = 0^\circ \text{ to } +70^\circ\text{C}$	PDIP-8 (Pb-Free)	50 Units / Rail
	MC34072APG		PDIP-8 (Pb-Free)	
	MC34072DG		SOIC-8 (Pb-Free)	98 Units / Rail
	MC34072ADG		SOIC-8 (Pb-Free)	
	MC34072DR2G		SOIC-8 (Pb-Free)	2500 Units / Tape & Reel
	MC34072ADR2G		SOIC-8 (Pb-Free)	
	MC34072AMTTBG		WQFN10 (Pb-Free)	
	MC33072PG		$T_A = -40^\circ \text{ to } +85^\circ\text{C}$	PDIP-8 (Pb-Free)
	MC33072APG	PDIP-8 (Pb-Free)		
	MC33072DG	SOIC-8 (Pb-Free)		98 Units / Rail
	MC33072ADG	SOIC-8 (Pb-Free)		
	MC33072DR2G	SOIC-8 (Pb-Free)		2500 / Tape & Reel
	MC33072ADR2G	SOIC-8 (Pb-Free)		
	MC34072VDG	$T_A = -40^\circ \text{ to } +125^\circ\text{C}$	SOIC-8 (Pb-Free)	98 Units / Rail
	MC34072VDR2G		SOIC-8 (Pb-Free)	2500 / Tape & Reel
	MC34072VPG		PDIP-8 (Pb-Free)	50 Units / Rail
	NCV33072DR2G*		SOIC-8 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NCV prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q100 qualified and PPAP capable.

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

ORDERING INFORMATION (continued)

Op Amp Function	Device	Operating Temperature Range	Package	Shipping†
Quad	MC34074PG	$T_A = 0^\circ$ to $+70^\circ\text{C}$	PDIP-14 (Pb-Free)	25 Units / Rail
	MC34074APG		PDIP-14 (Pb-Free)	
	MC34074DG		SOIC-14 (Pb-Free)	55 Units / Rail
	MC34074ADG		SOIC-14 (Pb-Free)	
	MC34074ADR2G		SOIC-14 (Pb-Free)	2500 Units / Tape & Reel
	MC34074DR2G		SOIC-14 (Pb-Free)	
	MC33074PG	$T_A = -40^\circ$ to $+85^\circ\text{C}$	PDIP-14 (Pb-Free)	25 Units / Rail
	MC33074APG		PDIP-14 (Pb-Free)	
	MC33074DG		SOIC-14 (Pb-Free)	55 Units / Rail
	MC33074ADG		SOIC-14 (Pb-Free)	
	MC33074DR2G		SOIC-14 (Pb-Free)	2500 / Tape & Reel
	NCV33074DR2G*		SOIC-14 (Pb-Free)	
	MC33074ADR2G		SOIC-14 (Pb-Free)	2500 / Tape & Reel
	NCV33074ADR2G*		SOIC-14 (Pb-Free)	
	MC33074DTBG		TSSOP-14 (Pb-Free)	96 Units / Rail
	MC33074DTBR2G		TSSOP-14 (Pb-Free)	2500 / Tape & Reel
	MC33074ADTBG		TSSOP-14 (Pb-Free)	96 Units / Rail
	MC33074ADTBR2G		TSSOP-14 (Pb-Free)	2500 / Tape & Reel
	NCV33074ADTBR2G*		TSSOP-14 (Pb-Free)	
	MC34074VDG		$T_A = -40^\circ$ to $+125^\circ\text{C}$	SOIC-14 (Pb-Free)
MC34074VDR2G	SOIC-14 (Pb-Free)	2500 / Tape & Reel		
NCV34074VDR2G*	SOIC-14 (Pb-Free)			
MC34074VPG	PDIP-14 (Pb-Free)	25 Units / Rail		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NCV prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q100 qualified and PPAP capable.

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

MARKING DIAGRAMS

PDIP-8 P SUFFIX CASE 626

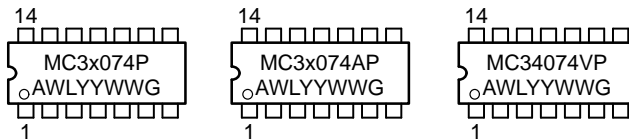


SOIC-8 D SUFFIX CASE 751

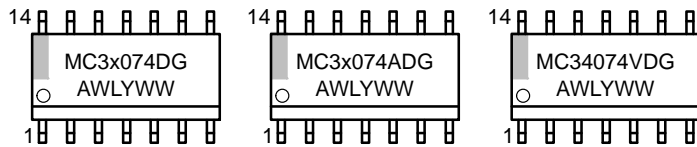


*applies to NCV33072DR2G

PDIP-14 P SUFFIX CASE 646



SOIC-14 D SUFFIX CASE 751A

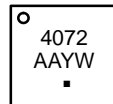


*applies to NCV34074VDR2G

TSSOP-14 DTB SUFFIX CASE 948G



WQFN10 MT SUFFIX CASE 510AJ



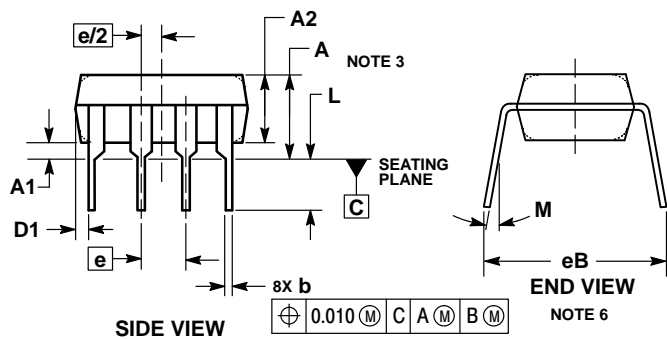
- x = 3 or 4
- A = Assembly Location
- WL, L = Wafer Lot
- YY, Y = Year
- WW, W = Work Week
- G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

PACKAGE DIMENSIONS

8 LEAD PDIP CASE 626-05 ISSUE N

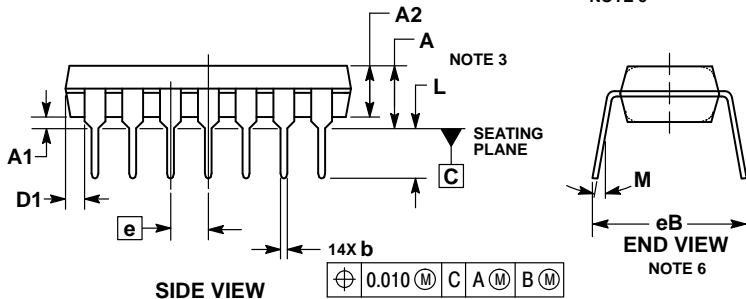
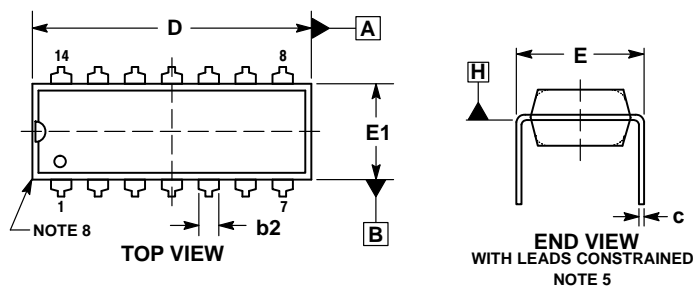


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.
4. DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
5. DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
6. DIMENSION E3 IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
7. DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	---	0.210	---	5.33
A1	0.015	---	0.38	---
A2	0.115	0.195	2.92	4.95
b	0.014	0.022	0.35	0.56
b2	0.060 TYP		1.52 TYP	
C	0.008	0.014	0.20	0.36
D	0.355	0.400	9.02	10.16
D1	0.005	---	0.13	---
E	0.300	0.325	7.62	8.26
E1	0.240	0.280	6.10	7.11
e	0.100 BSC		2.54 BSC	
eB	---	0.430	---	10.92
L	0.115	0.150	2.92	3.81
M	---	10°	---	10°

PDIP-14 CASE 646-06 ISSUE R



NOTES:

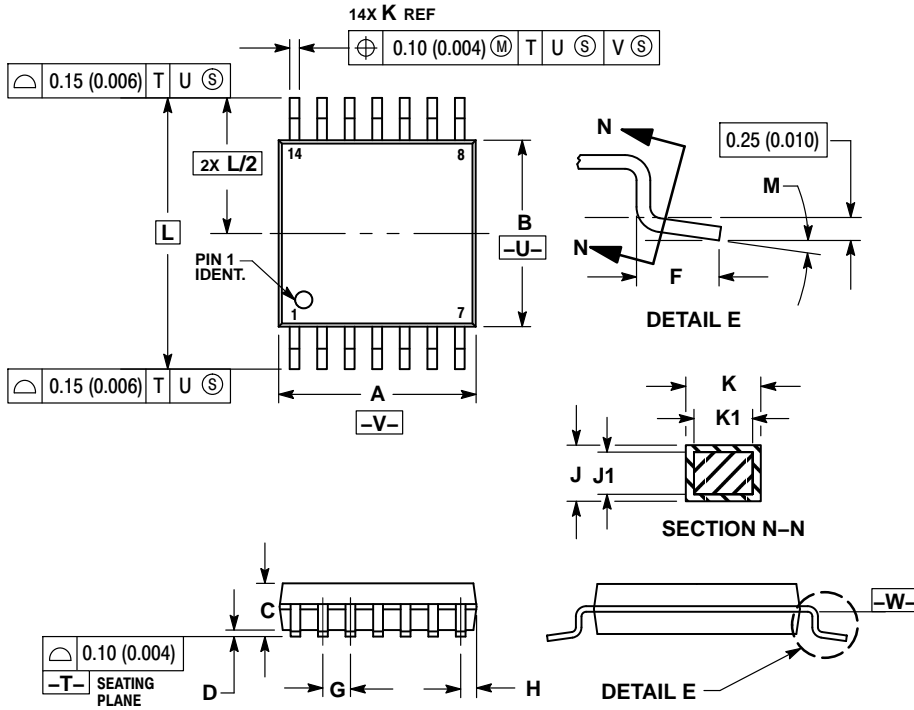
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSIONS A, A1 AND L ARE MEASURED WITH THE PACKAGE SEATED IN JEDEC SEATING PLANE GAUGE GS-3.
4. DIMENSIONS D, D1 AND E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS ARE NOT TO EXCEED 0.10 INCH.
5. DIMENSION E IS MEASURED AT A POINT 0.015 BELOW DATUM PLANE H WITH THE LEADS CONSTRAINED PERPENDICULAR TO DATUM C.
6. DIMENSION E3 IS MEASURED AT THE LEAD TIPS WITH THE LEADS UNCONSTRAINED.
7. DATUM PLANE H IS COINCIDENT WITH THE BOTTOM OF THE LEADS, WHERE THE LEADS EXIT THE BODY.
8. PACKAGE CONTOUR IS OPTIONAL (ROUNDED OR SQUARE CORNERS).

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	---	0.210	---	5.33
A1	0.015	---	0.38	---
A2	0.115	0.195	2.92	4.95
b	0.014	0.022	0.35	0.56
b2	0.060 TYP		1.52 TYP	
C	0.008	0.014	0.20	0.36
D	0.735	0.775	18.67	19.69
D1	0.005	---	0.13	---
E	0.300	0.325	7.62	8.26
E1	0.240	0.280	6.10	7.11
e	0.100 BSC		2.54 BSC	
eB	---	0.430	---	10.92
L	0.115	0.150	2.92	3.81
M	---	10°	---	10°

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

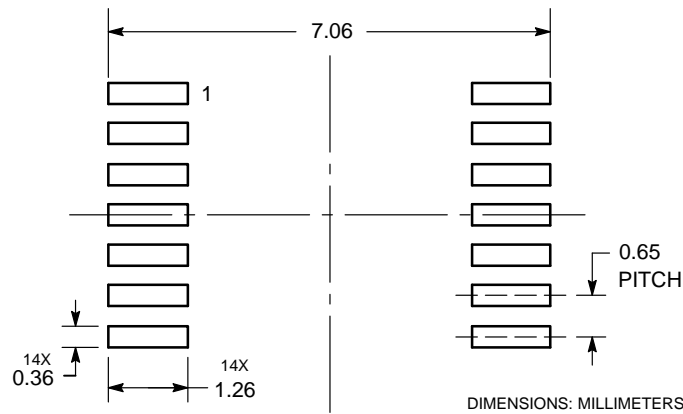
PACKAGE DIMENSIONS

TSSOP-14
CASE 948G
ISSUE B



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
 6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE - W.

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

PACKAGE DIMENSIONS

SOIC-8 NB
CASE 751-07
ISSUE AK

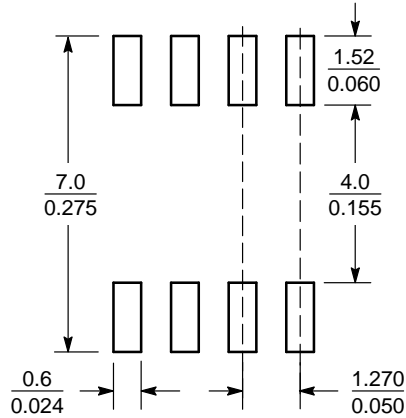


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0°	8°	0°	8°
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

SOLDERING FOOTPRINT*



SCALE 6:1 (mm/inches)

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

PACKAGE DIMENSIONS

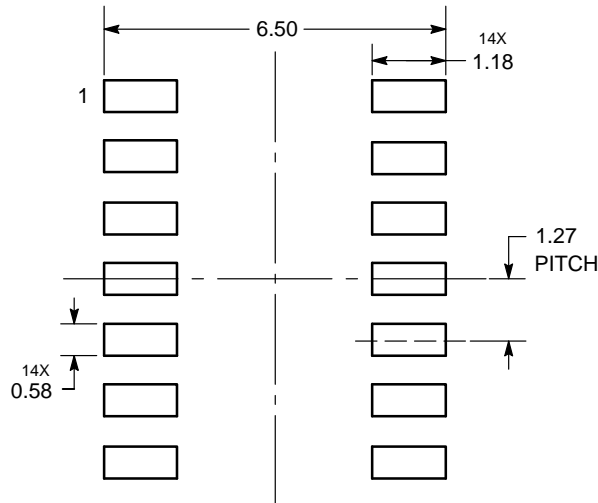
SOIC-14
CASE 751A-03
ISSUE K



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
 5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	1.35	1.75	0.054	0.068
A1	0.10	0.25	0.004	0.010
A3	0.19	0.25	0.008	0.010
b	0.35	0.49	0.014	0.019
D	8.55	8.75	0.337	0.344
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.019
L	0.40	1.25	0.016	0.049
M	0°	7°	0°	7°

SOLDERING FOOTPRINT*



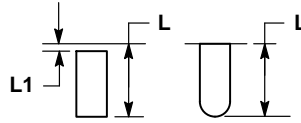
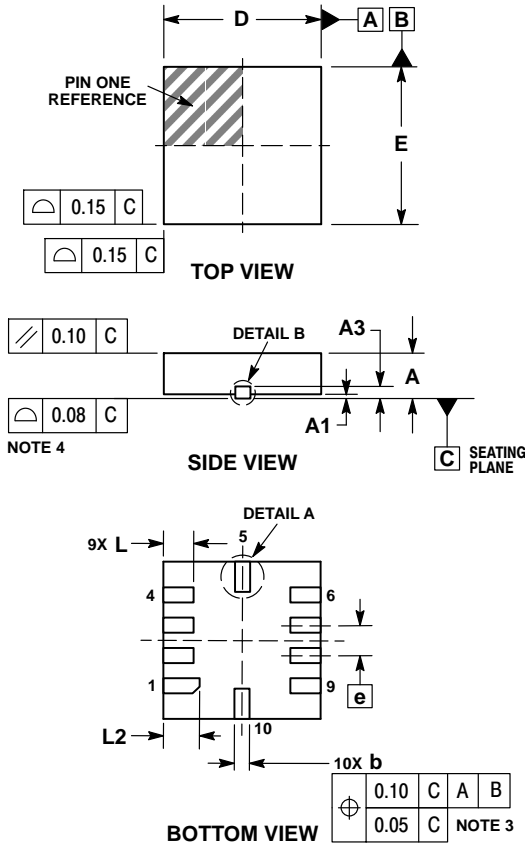
DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

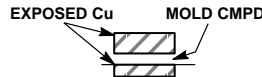
MC34071,2,4,A MC33071,2,4,A, NCV33072,4,A

PACKAGE DIMENSIONS

WQFN10 CASE 510AJ ISSUE A



**DETAIL A
ALTERNATE TERMINAL
CONSTRUCTIONS**



**DETAIL B
ALTERNATE
CONSTRUCTIONS**

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30mm FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.70	0.80
A1	0.00	0.05
A3	0.20 REF	
b	0.20	0.30
D	2.60 BSC	
E	2.60 BSC	
e	0.50 BSC	
L	0.45	0.55
L1	0.00	0.15
L2	0.55	0.65

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

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